

3.0mmx1.0 mm RIGHT ANGLE SMD **CHIP LED LAMP**

Part Number: APA3010MGC-GX Mega Green

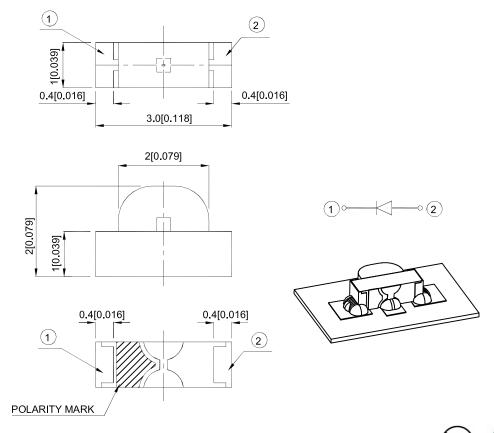
Features

- 3.0x2.0x1.0mm right angle SMD LED, 1.0mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for back light and indicator.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- RoHS compliant.

Description

The Mega Green source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.15(0.006") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

| Part No. | Emitting Color (Material) | Lens Type | lv (mcd) [2] @ 20mA | | | Viewing Angle [1] |
|---------------|---------------------------|-------------|------------------------|------|------|----------------------|
| | | | Min. | Тур. | Max. | 201/2 |
| APA3010MGC-GX | Mega Green (AlGaInP) | Water Clear | 40 | 60 | 80 | 120° |

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity / luminous Flux: +/-15%.
 Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Emitting Color | Тур. | Max. | Units | Test Conditions |
|--------|--------------------------|----------------|------|------|-------|-----------------|
| λpeak | Peak Wavelength | Mega Green | 574 | | nm | IF=20mA |
| λD [1] | Dominant Wavelength | Mega Green | 570 | 571 | nm | IF=20mA |
| Δλ1/2 | Spectral Line Half-width | Mega Green | 26 | | nm | IF=20mA |
| С | Capacitance | Mega Green | 20 | | pF | VF=0V;f=1MHz |
| VF [2] | Forward Voltage | Mega Green | 2.1 | 2.5 | V | IF=20mA |
| lr | Reverse Current | Mega Green | | 10 | uA | VR=5V |

Notes:

- 1. Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.
- Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

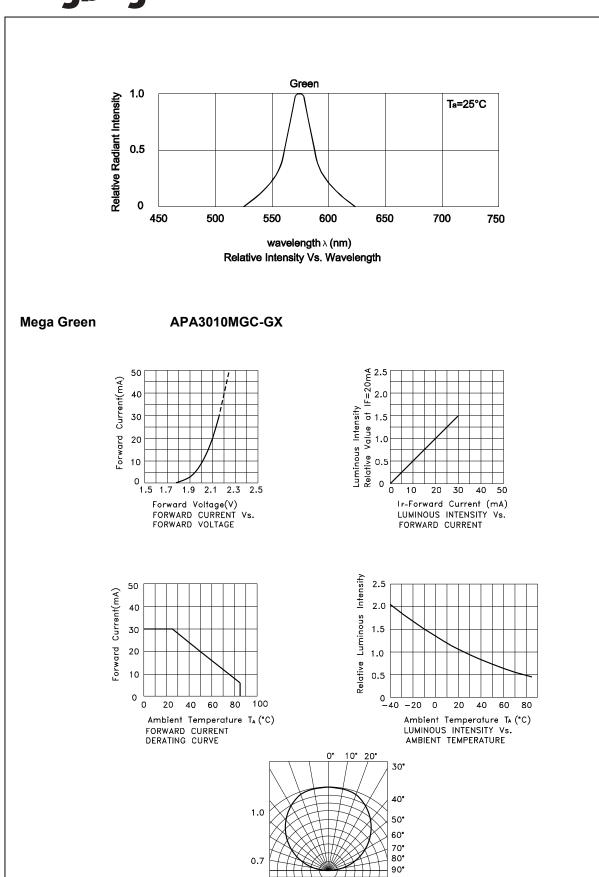
Absolute Maximum Ratings at TA=25°C

| Parameter | Values | Units | |
|--------------------------|----------------|-------|--|
| Tarameter | Values | Onto | |
| Power dissipation | 75 | mW | |
| DC Forward Current | 30 | mA | |
| Peak Forward Current [1] | 150 | mA | |
| Reverse Voltage | 5 | V | |
| Operating Temperature | -40°C To +85°C | | |
| Storage Temperature | -40°C To +85°C | | |

- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity - Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

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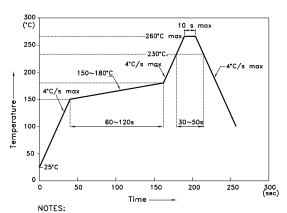
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

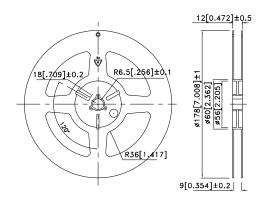
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

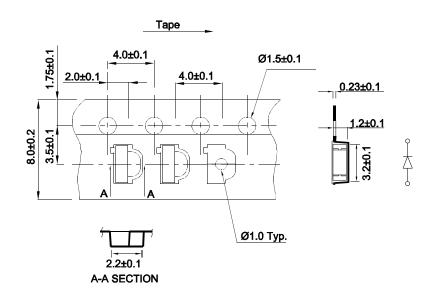
 3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

Tape Dimensions (Units: mm)

Reel Dimension



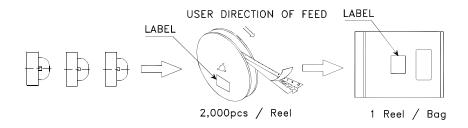


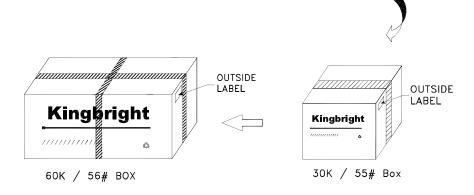
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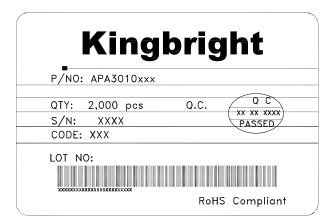
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PACKING & LABEL SPECIFICATIONS

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